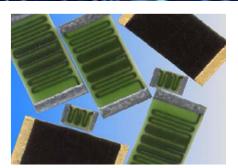
HVC Series High Voltage Thick Film Chip Resistor

Stackpole Electronics, Inc.

Resistive Product Solutions

Features:

- Available with wire bondable terminations
- Utilizes fine film resistor deposition technology
- Superior pulse handling capabilities
- Low TCR to 25 ppm/°C
- Low VCR to 1 ppm/volt
- Very low noise
- Ultra-high stability
- Higher (up to 1TΩ) or lower resistance values may be available (contact Stackpole)
- RoHS compliant, REACH compliant, and halogen free



				Ele	ctrical Sp	ecificatio	ns					
Type / Code	Power Rating (W)	Maximum Working Voltage ^(V)	TCR (ppm/⁰C)		Ohmic Range (Ω) and Tolerance							
	@ 70ºC	(1)		0.1%	0.25%	0.5%	1%	2%	5%	10%	20%	
			±50				10K - 100M		10K -	500M		
HVC0603	0.06	400	±100 ±200		-	10K - 10M	10K - 500M	10K	- 1G		- 1G 10K - 50G	
			±50						10K - 500M	1010 100	1011 000	
HVC0805	0.2	600	±100		-	10K - 10M				10K - 1G		
			±200				10K -	1G	10K -	· 10G	10K - 50G	
			±25	1M - 100M 1M - 100M								
HVC1206	0.33	1500	±50	100K - 100M	100K - 100M			100K - 5				
HVC1200	0.55	1500	±100	10K - 100M	10K - 100M	10K - 500M	10K - 1G		10K	- 1G		
			±200			1010 - 300101	10K - 10		10K - 10G		10K - 50G	
			±25	1M - 100M		1	11	M - 100M				
HVC2010	1	2000	±50	100K - 100M	100K - 100M			100K - 5				
		2000	±100	10K - 100M	10K - 100M	10K - 500M	10K - 1G		10K	- 1G		
			±200						10K - 10G		10K - 50G	
			±25	1M - 100M			1	M - 500M				
HVC2512	2	3000	±50	100K - 100M	100K - 500M			100K -	· 1G			
			±100 ±200	10K - 100M	10K - 500M	10K - 1G		10K - 10G			- 10G - 50G	
			±200 ±25	1M - 100M		1	11	M - 500M		10010	000	
			±20 ±50	100K - 100M	100K - 500M			100K -	- 1G			
HVC3512	3	3 3500	±100 ±200	10K - 100M	10K - 500M	10K - 1G		10K - 10G	-		- 10G - 50G	
L												

Proper terminal isolation is required to achieve the voltage ratings for each given size.

(1) The continuous maximum voltage applied cannot exceed the maximum power rating and is ohmic value dependent.

Note: Other case sizes and tolerances are available.

	Mechanical Specifications										
H t t t t t t t t t t t t t t t t t t t											
Type / Code	L Body Length	W Body Width	H Body Height (Max.)	a Top Termination	b Bottom Termination	Unit					
HVC0603	0.063 ± 0.01	0.031 ± 0.005	0.020	0.010 ± 0.005	0.012 ± 0.008	inches					
11100000	1.60 ± 0.25	0.79 ± 0.13	0.51	0.25 ± 0.13	0.30 ± 0.20	mm					
HVC0805	0.079 ± 0.01	0.050 ± 0.005	0.025	0.010 ± 0.005	0.013 ± 0.008	inches					
	2.01 ± 0.25	1.27 ± 0.13	0.64	0.25 ± 0.13	0.33 ± 0.20	mm					
	0.126 ± 0.01	0.063 ± 0.005	0.030	0.010 ± 0.005	0.020 ± 0.010	inches					
HVC1206	3.20 ± 0.25	1.60 ± 0.13	0.76	0.25 ± 0.13	0.51 ± 0.25	mm					

High Voltage Thick Film Chip Resistor

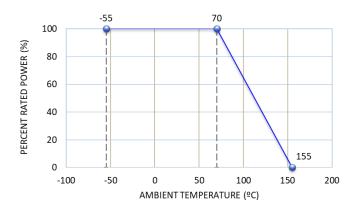
Stackpole Electronics, Inc. Resistive Product Solutions

	Mechanical Specifications (cont.)											
Type / Code	L Body Length	W Body Width	H Body Height (Max.)	a Top Termination	b Bottom Termination	Unit						
HVC2010	0.200 ± 0.01	0.100 ± 0.005	0.030	0.018 ± 0.010	0.020 ± 0.010	inches						
	5.08 ± 0.25	2.54 ± 0.13	0.76	0.46 ± 0.25	0.51 ± 0.25	mm						
HVC2512	0.250 ± 0.01	0.125 ± 0.005	0.030	0.020 ± 0.010	0.024 ± 0.010	inches						
	6.35 ± 0.25	3.18 ± 0.13	0.76	0.51 ± 0.25	0.61 ± 0.25	mm						
HVC3512	0.350 ± 0.01	0.125 ± 0.005	0.030	0.020 ± 0.010	0.024 ± 0.010	inches						
	8.89 ± 0.25	3.18 ± 0.13	0.76	0.51 ± 0.25	0.61 ± 0.25	mm						

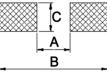
Performance	Characteristics				
Test	Typical Performance				
Short Time Overload	0.1%				
Load Life	0.1%				
Temperature Cycle	0.1%				
Moisture Resistance	0.1%				
Shock	0.05%				
Vibration	0.05%				
Dielectric Withstanding Voltage	0.05%				
Resistance to Soldering Heat	0.05%				
Parameter	Typical				
TCR	measured from 25°C to 75°C				
Pulse Capability	10X rated wattage Consult Stackpole for custom pulse applications				
Resistance Value	Measured at 100V Consult Stackpole for custom test voltages				

Operating temperature range is -55°C to +155°C

Power Derating Curve:



Recommended Pad Layouts



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Type / Code	А	В	С	Unit
HVC0603	0.031	0.083	0.035	inches
HVC0003	0.80	2.10	0.90	mm
HVC0805	0.047	0.118	0.051	inches
HVC0805	1.20	3.00	1.30	mm

Rev Date: 3/27/2024

This specification may be changed at any time without prior notice Please confirm technical specifications before use.

High Voltage Thick Film Chip Resistor

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	Recommended Pad Layouts (cont.)										
Type/Code	A	В	С	Unit							
HVC1206	0.087	0.165	0.063	inches							
HVC1206	2.20	4.20	1.60	mm							
HVC2010	0.138	0.240	0.110	inches							
HVC2010	3.50	6.10	2.80	mm							
HVC2512	0.193	0.315	0.138	inches							
HVC2512	4.90	8.00	3.50	mm							
HVC3512	0.290	0.415	0.138	inches							
HVC3512	7.37	10.54	3.50	mm							

Recommended Solder Profile

This information is intended as a reference for solder profiles for Stackpole resistive components. These profiles should be compatible with most soldering processes. These are only recommendations. Actual numbers will depend on board density, geometry, packages used, etc., especially those cells labeled with "*".

100% Matte Tin / RoHS Compliant Terminations

Soldering iron recommended temperatures: 330°C to 350°C with minimum duration. Maximum number of reflow cycles: 3.

Wave Soldering										
Description Maximum Recommended Minimum										
Preheat Time	80 seconds	70 seconds	60 seconds							
Temperature Diff.	140°C	120°C	100°C							
Solder Temp.	260°C	250°C	240°C							
Dwell Time at Max	10 seconds	5 seconds	*							
Ramp DN (°C/sec)	N/A	N/A	N/A							

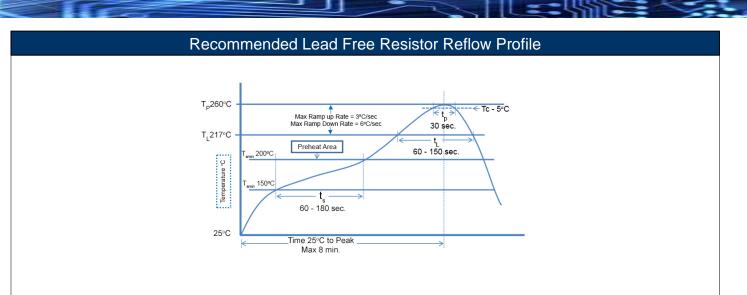
Temperature Diff. = Difference between final preheat stage and soldering stage.

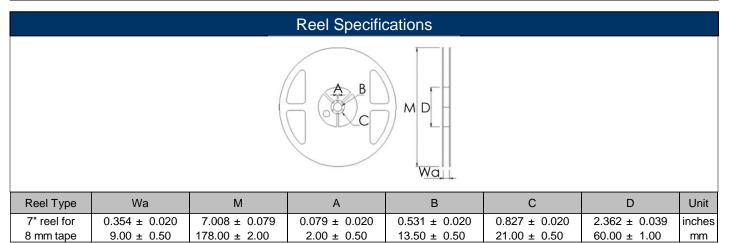
	Convection IR Reflow										
Description	Maximum	Recommended	Minimum								
Ramp Up (°C/sec)	3°C/sec	2°C/sec	*								
Dwell Time > 217°C	150 seconds	90 seconds	60 seconds								
Solder Temp.	260°C	245°C	*								
Dwell Time at Max.	30 seconds	15 seconds	10 seconds								
Ramp DN (°C/sec)	6°C/sec	3°C/sec	*								

High Voltage Thick Film Chip Resistor

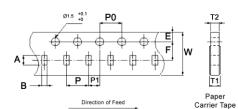
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Paper Tape Specifications



Type/Code	7" Reel Quantity ⁽¹⁾	Typical Full Reel Weight (g)	Tape Width	А	В	W	E	Unit
HVC0603	5000	118.3 ± 11.0		0.071 ± 0.008 1.80 ± 0.20	0.041 ± 0.008 1.05 ± 0.20			inches mm
HVC0805	5000	139.2 ± 13.0	0.315 8.00	0.093 ± 0.010 2.35 ± 0.25	0.063 ± 0.010 1.60 ± 0.25	0.315 ± 0.008 8.00 ± 0.20	0.069 ± 0.004 1.75 ± 0.10	inches mm
HVC1206	4000	151.4 ± 15.0		0.140 ± 0.010 3.55 ± 0.25	0.077 ± 0.010 1.95 ± 0.25			inches mm

(1) Quantities shown here are for T packaging only.

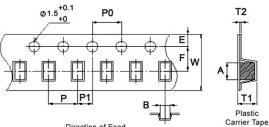
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High Voltage Thick Film Chip Resistor

Stackpole Electronics, Inc. Resistive Product Solutions

	Paper Tape Specifications (cont.)											
Type/Code	F	T1	T2	Р	P0	P1	Unit					
HVC0603		0.024 ± 0.008	0.024 ± 0.004				inches					
HVC0803		0.60 ± 0.20	0.60 ± 0.10				mm					
HVC0805		0.030 ± 0.008	0.030 ± 0.004				inches					
HVC0805	0.138 ± 0.002	0.75 ± 0.20	0.75 ± 0.10	0.157 ± 0.004	0.157 ± 0.004	0.079 ± 0.002	mm					
HVC1206	3.50 ± 0.05	0.030 ± 0.008	0.030 ± 0.004	4.00 ± 0.10	4.00 ± 0.10	2.00 ± 0.05	inches					
HVC1206		0.75 ± 0.20	0.75 ± 0.10				mm					
LIVC2010		0.030 ± 0.008	0.030 ± 0.004				inches					
HVC2010		0.75 ± 0.20	0.75 ± 0.10				mm					

Plastic Tape Specifications



Direction of Feed

Type/Code	7" Reel Quantity ^(*)	Typical Full Reel Weight (g)	Tape Width	А	В	W	E	F	Unit
HVC2010	4000	183.1 ± 18.0		0.217 ± 0.012 5.50 ± 0.30		0.472 ± 0.008 12.00 ± 0.20		0.217 ± 0.002 5.50 ± 0.05	inches mm
HVC2512	2000	255.3 ± 25.0	0.472	0.264 ± 0.008					
11002312	2000	200.0 ± 20.0	12.00	6.70 ± 0.20		12.00 ± 0.20			mm
HVC3512	1000	255.3 ± 25.0		0.370 ± 0.004 9.40 ± 0.10		0.945 ± 0.012 24.00 ± 0.30			inches mm

(*) Quantities shown here are for T packaging only.

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Type/Code	T1	T2	Р	P0	P1	Unit
HVC2010						inches
						mm
HVC2512	0.041 ± 0.008	0.009 ± 0.006	0.157 ± 0.004	0.157 ± 0.004	0.079 ± 0.002	inches
11102012	1.05 ± 0.20	0.23 ± 0.15	4.00 ± 0.10	4.00 ± 0.10	2.00 ± 0.05	mm
HVC3512						inches
11003312						mm

Part Marking

Parts are unmarked.

RoHS Compliance

Stackpole Electronics has joined the worldwide effort to reduce the amount of lead in electronic components and to meet the various regulatory requirements now prevalent, such as the European Union's directive regarding "Restrictions on Hazardous Substances" (RoHS 3). As part of this ongoing program, we periodically update this document with the status regarding the availability of our compliant components. All our standard part numbers are compliant to EU Directive 2011/65/EU of the European Parliament as amended by Directive (EU) 2015/863/EU as regards the list of restricted substances.

RoHS Compliance Status									
Standard Product Series	Description	Package / Termination Type	Standard Series RoHS Compliant	Lead-Free Termination Composition	Lead-Free Mfg. Effective Date (Std Product Series)	Lead-Free Effective Date Code (YY/WW)			
HVC	High Voltage Thick Film Surface Mount Chip Resistor	SMD	YES(1)	100% Matte Sn ("T")	Always	Always			

Note (1): RoHS Compliant by means of exemption 7c-I.

"Conflict Metals" Commitment

We at Stackpole Electronics, Inc. are joined with our industry in opposing the use of metals mined in the "conflict region" of the eastern Democratic Republic of the Congo (DRC) in our products. Recognizing that the supply chain for metals used in the electronics industry is very complex, we work closely with our own suppliers to verify to the extent possible that the materials and products we supply do not contain metals sourced from this conflict region. As such, we are in compliance with the requirements of Dodd-Frank Act regarding Conflict Minerals.

Compliance to "REACH"

We certify that all passive components supplied by Stackpole Electronics, Inc. are SVHC (Substances of Very High Concern) free and compliant with the requirements of EU Directive 1907/2006/EC, "The Registration, Evaluation, Authorization and Restriction of Chemicals", otherwise referred to as REACH. Contact us for complete list of REACH Substance Candidate List.

Environmental Policy

It is the policy of Stackpole Electronics, Inc. (SEI) to protect the environment in all localities in which we operate. We continually strive to improve our effect on the environment. We observe all applicable laws and regulations regarding the protection of our environment and all requests related to the environment to which we have agreed. We are committed to the prevention of all forms of pollution.

